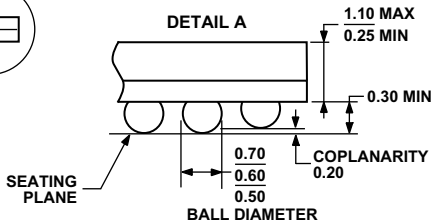
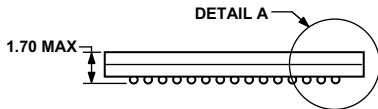
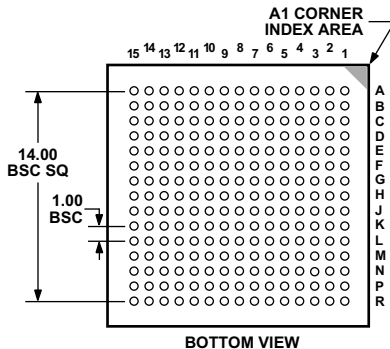
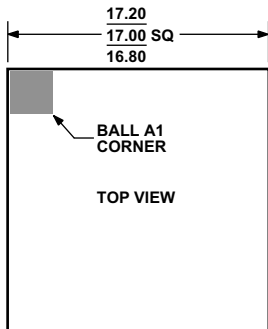


225-Lead Chip Scale Package Ball Grid Array [CSP_BGA]

(BC-225)

Dimensions shown in millimeters

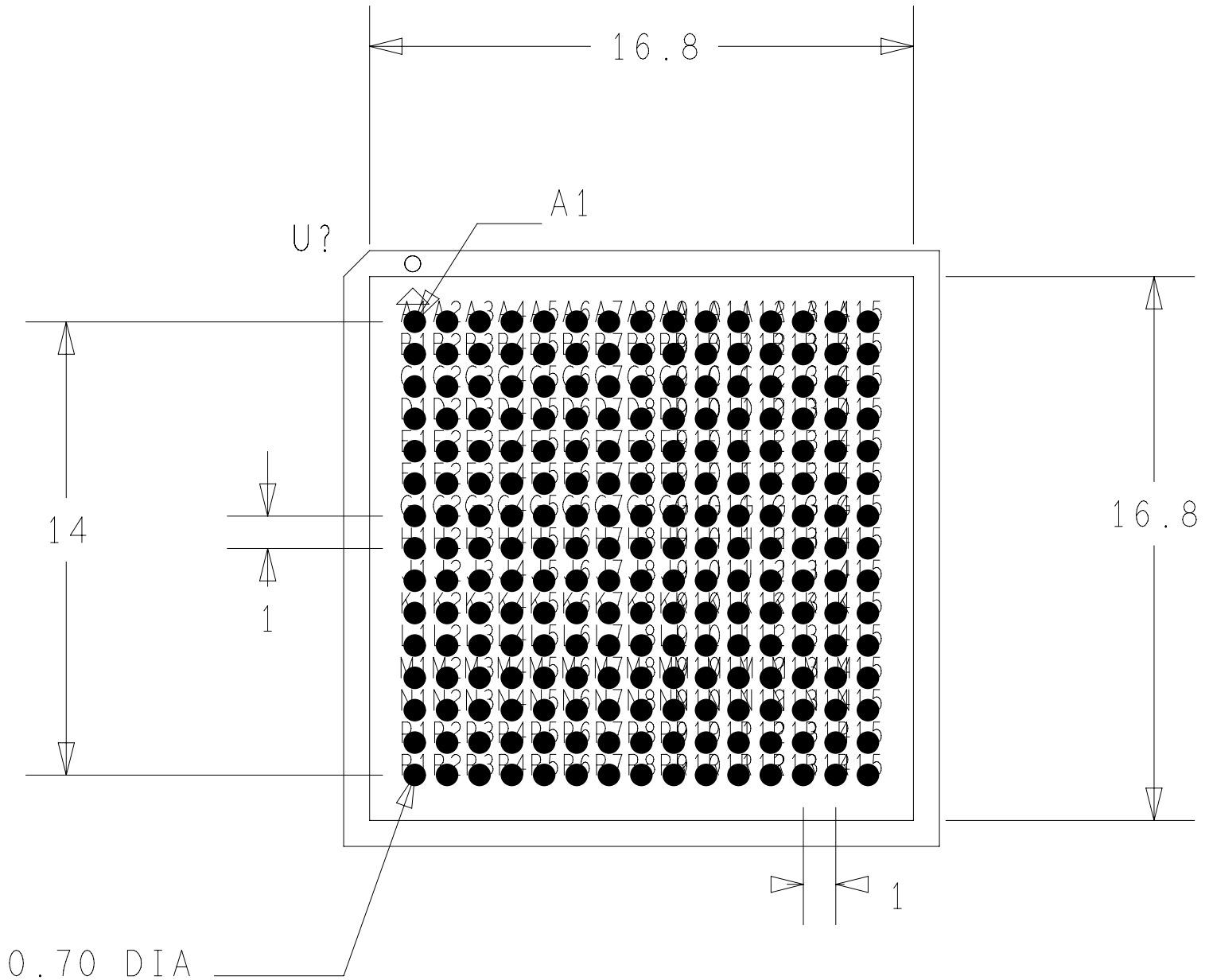


COMPLIANT TO JEDEC STANDARDS MO-192-AAF-2

Analog Devices

BC-225

REV A



(Dim. are in MM)

LAST MODIFIED 09/13/07